

NPN General-Purpose Amplifier

MMBT5551

Description

This device is designed for general-purpose high-voltage amplifiers and gas discharge display drivers.

Features

• This Devices is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (Note 1)

| Symbol | Parameter | Value | Unit |
|-----------------------------------|--|--------------|------|
| V _{CEO} | Collector-Emitter Voltage | 160 | V |
| V _{CBO} | Collector-Base Voltage | 180 | V |
| V _{EBO} | Emitter-Base Voltage | 6 | ٧ |
| I _C | Collector Current - Continuous | 600 | mA |
| T _J , T _{STG} | Operating and Storage Temperature (Note 2) | -55 to + 150 | ç |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
- These ratings are based on a maximum junction temperature of 150°C. These
 are steady-state limits. onsemi should be consulted on applications involving
 pulsed or low-duty cycle operations.



1. Base 2. Emitter 3. Collector

SOT-23-3 CASE 318BM

MARKING DIAGRAM



kY = **onsemi** Logo

3S = Specific Device Code &E = Designated Space

&E = Designated Space &G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Note 3)

| Symbol | Characteristic | Max | Unit |
|----------------|---|-----|-------|
| P _D | Total Device Dissipation | 350 | mW |
| | Derate Above 25°C | 2.8 | mW/°C |
| $R_{	hetaJA}$ | Thermal Resistance, Junction to Ambient | 357 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Note 4)

| Symbol | Parameter | Test Conditions | Min | Max | Unit |
|----------------------|-------------------------------------|---|-----|-----|------|
| V _{(BR)CEO} | Collector-Emitter Breakdown Voltage | $I_C = 1.0 \text{ mA}, I_B = 0$ | 160 | | V |
| V _{(BR)CBO} | Collector-Base Breakdown Voltage | $I_C = 100 \mu A, I_E = 0$ | 180 | | V |
| V _{(BR)EBO} | Emitter-Base Breakdown Voltage | $I_E = 10 \mu A, I_C = 0$ | 6.0 | | V |
| I _{CBO} | Collector Cut-Off Current | V _{CB} = 120 V, I _E = 0 | | 50 | nA |
| | | V _{CB} = 120 V, I _E = 0 V, T _A = 100°C | | 50 | μΑ |
| I _{EBO} | Emitter Cut-Off Current | $V_{EB} = 4.0 \text{ V}, I_{C} = 0$ | | 50 | nA |

ON CHARACTERISTICS

| h _{FE} | DC Current Gain | $I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$ | 80 | | |
|----------------------|--------------------------------------|---|-----|------|---|
| | | $I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$ | 80 | 250 | |
| | | I _C = 10 mA, V _{CE} = 5.0 V (for 2N5551YBU, 2N5551YTA) | 180 | 240 | |
| | | $I_C = 50 \text{ mA}, V_{CE} = 5.0 \text{ V}$ | 30 | | |
| V _{CE(sat)} | Collector–Emitter Saturation Voltage | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ | | 0.15 | V |
| | | $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$ | | 0.20 | V |
| V _{BE(sat)} | Base-Emitter On Voltage | $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ | | 1.0 | V |
| | | $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$ | | 1.0 | V |

SMALL-SIGNAL CHARACTERISTICS

| f _T | Current Gain Bandwidth Product | $I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$ | 100 | | MHz |
|------------------|--------------------------------|---|-----|-----|-----|
| C _{obo} | Output Capacitance | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1.0 \text{ MHz}$ | | 6.0 | pF |
| C _{ibo} | Input Capacitance | $V_{BE} = 0.5 \text{ V}, I_{C} = 0, f = 1.0 \text{ MHz}$ | | 20 | pF |
| H _{fe} | Small-Signal Current Gain | I_{C} = 1.0 mA, V_{CE} = 10 V, f = 1.0 kHz | 50 | 250 | |
| NF | Noise Figure | I_C = 250 μA, V_{CE} = 5.0 V, R_S = 1.0 kΩ, f = 10 Hz to 15.7 kHz | | 8.0 | dB |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. PCB board size FR-4 76 x 114 x 0.6 T mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

4. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2.0%.

TYPICAL PERFORMANCE CHARACTERISTICS

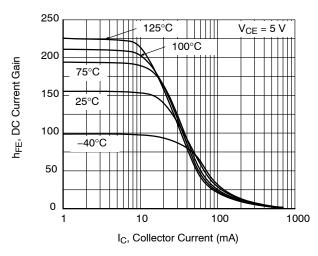


Figure 1. Typical Pulsed Current Gain vs. Collector Current

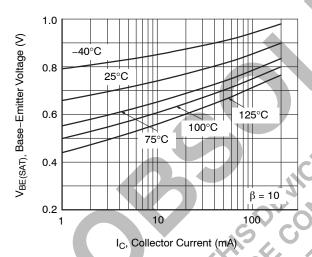


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

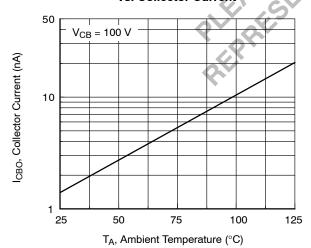


Figure 5. Collector Cut-Off Current vs. Ambient Temperature

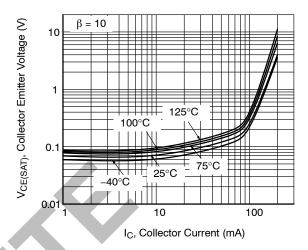


Figure 2. Collector – Emitter Saturation Voltage vs. Collector Current

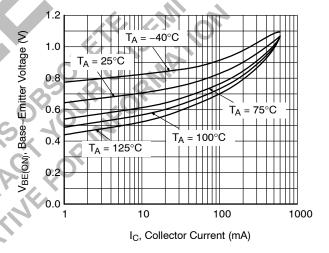


Figure 4. Base-Emitter On Voltage vs. Collector Current

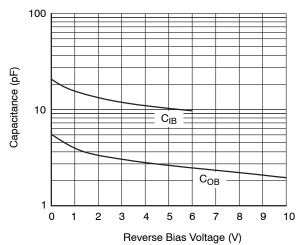
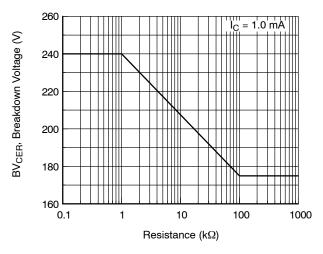
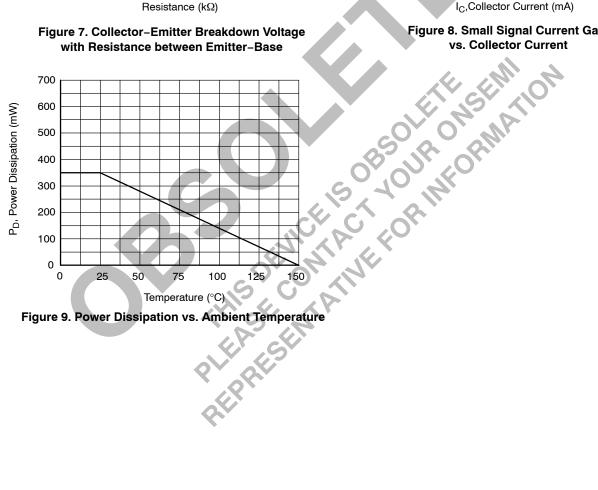


Figure 6. Input and Output Capacitance vs. Reverse Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (continued)





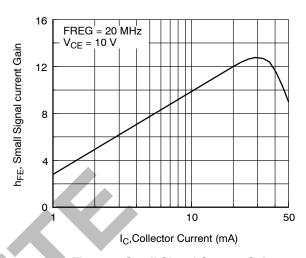


Figure 8. Small Signal Current Gain

ORDERING INFORMATION (Note 72)

| Part Number | Top Mark | Package | Shipping [†] |
|-------------|----------|--------------------|-----------------------|
| MMBT5551 | 38 | SOT-23-3 (Pb-Free) | 3,000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





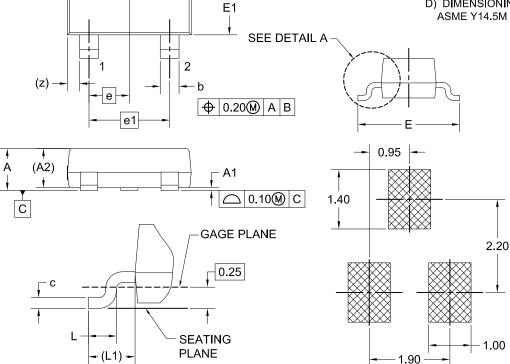


SOT-23 CASE 318BM ISSUE A

DATE 01 SEP 2021



- A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M 2009.



Α

В

| DIM | MILLIMETERS | | | |
|-----|-------------|----------|------|--|
| Diw | MIN. | NOM. | MAX. | |
| Α | | | 1.20 | |
| A1 | 0.00 | 0.05 | 0.10 | |
| A2 | |).93 REF | | |
| b | 0.37 | 0.44 | 0.60 | |
| С | 0.08 | 0.15 | 0.23 | |
| D | 2.72 | 2.92 | 3.12 | |
| Е | 2.10 | 2.40 | 2.70 | |
| E1 | 1.15 | 1.30 | 1.50 | |
| е | (| 0.95 BSC | ; | |
| e1 | , | 1.90 BSC | ; | |
| L | 0.20 | | | |
| L1 | 0.55 REF | | | |
| z | 0.29 REF | | | |
| | | | | |

LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR

GENERIC PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

DETAIL A

This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "", may

not follow the Generic Marking.

or may not be present. Some products may

| XX | X = Specific Device Code |
|----|--------------------------|
| M | = Date Code |
| • | = Pb-Free Package |

| DOCUMENT NUMBER: | 98AON13784G | Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED (| |
|------------------|-------------|--|-------------|
| DESCRIPTION: | SOT-23 | | PAGE 1 OF 1 |

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